

REMARKS

In the above referenced Office Action, the Examiner divided the claims into the following groups:

Group I, Claims 1-42, drawn to a subcombination semiconductor processing apparatus;

Group II, Claims 43-53, drawn to a method of spray coating;

Group III, Claims 54-102, drawn to wafer processor; and

Group IV, Claim 103, drawn to a method of handling a wafer.

In response, the applicants elect Group III without traverse. Although the Examiner includes claims 1-53 in this restriction requirement, those claims were cancelled in the 3 October 2001 preliminary amendment that added new claims 54-103.

New claim 104 is drawn to means for practicing the process of claim 103. As such, this claim should be examined with Group III and claim 103 should be rejoined if this claim is allowed. MPEP §806.05(e).

The undersigned has enclosed a check to cover the cost of one additional independent claim. If any further fees are due in connection with this amendment, please charge them to Deposit Account No. 50-0665.

Respectfully submitted,
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